



CERAMIC

Bandpass Filter

BFCQ-1932+

Mini-Circuits

50Ω 17.7 to 21 GHz

THE BIG DEAL

- Standard small 1008 (2.5mm x 2.0mm) case style
- Low Insertion Loss – Mid band 1.6 dB typical
- Wide rejection band
- Shielded construction preventing filter from de-tuning
- Reduced footprint area by employing LGA (land grid array)
- Surface mountable pick and place standard case style



Generic photo used for illustration purposes only

CASE STYLE: NL1008C-7

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

APPLICATIONS

- Satellite Communications

PRODUCT OVERVIEW

The BFCQ-1932+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance by utilizing a proprietary LTCC material system and distributed filter topology. The typical passband loss at 17.7 – 21 GHz is as low as 1.6 dB, with typical stopband rejections at 43 dB up to 40 GHz. This model handles up to 1W RF input power, and provides a wide operating temperature range from -55 to +125°C. Utilizing a proprietary LTCC material system and a distributed filter topology, this filter is able to achieve repeatable performance on a lot-to-lot basis.

KEY FEATURES

Feature	Advantages
Cost effective	LTCC is scalable technology that is cost effective due to ease of production in high quantities.
Small size (2.5mm x 2.0mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Surface Mountable	Suitable for very high volume automated assembly process.





CERAMIC

Bandpass Filter

BFCQ-1932+

Mini-Circuits

50Ω 17.7 to 21 GHz

ELECTRICAL SPECIFICATIONS¹ AT 25°C

Parameter	F#	Frequency (MHz)	Min.	Typ.	Max.	Units
Passband	Center Frequency	—	—	19.3	—	GHz
	Insertion Loss	F1-F2	17.7 - 21	1.6	3.0	dB
	Return Loss	F1-F2	17.7 - 21	—	12	dB
Stop Band, Lower	Insertion Loss	DC-F3	0.1 - 11	40	46	dB
			11 - 14.6	20	30	
Stop Band, Upper	Insertion Loss	F4-F5	25.6 - 28	30	40	dB
			28 - 35	40	50	
			35 - 40	30	43	

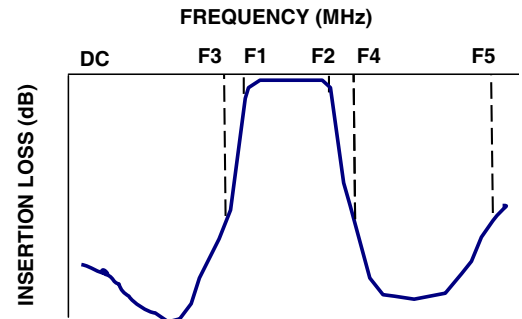
1. Measured on Mini-Circuits Test Board TB-BFCQ-1932C+ with feedline losses removed by normalization of S12 and S21 traces to measurement of the thru-line.

MAXIMUM RATINGS

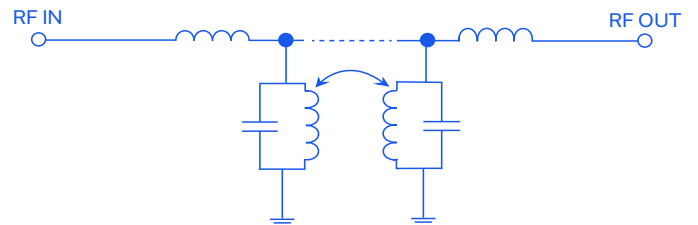
Parameter	Ratings
Operating temperature	-55°C to +125°C
Storage temperature	-55°C to +125°C
RF Power Input	1W

Permanent damage may occur if any of these limits are exceeded.

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC





CERAMIC

Bandpass Filter

BFCQ-1932+

Mini-Circuits

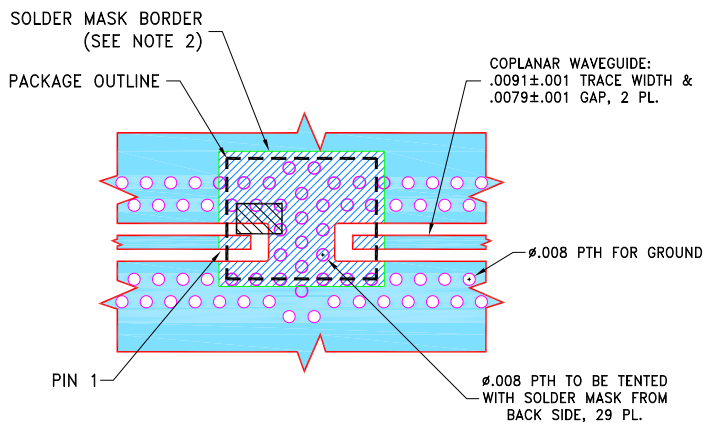
50Ω 17.7 to 21 GHz

PAD CONNECTIONS

INPUT	1
OUTPUT	2
GROUND	3

PRODUCT MARKING: UD

DEMO BOARD MCL P/N: TB-BFCQ-1932C+ SUGGESTED PCB LAYOUT (PL-707)

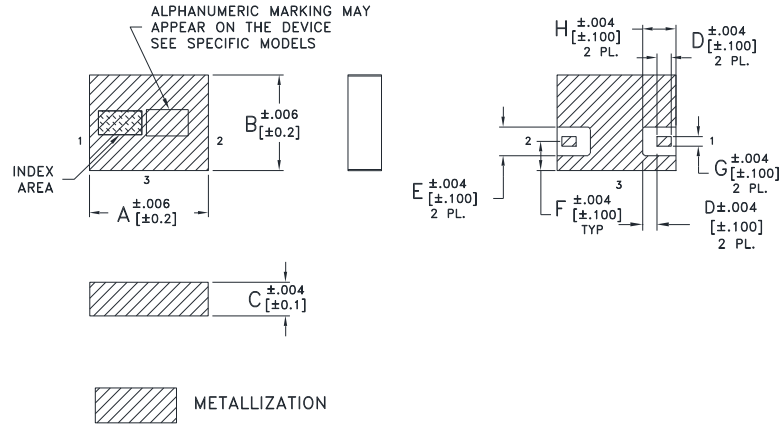


NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR MEGTRON-7 R5785(N); DIELECTRIC THICKNESS: .0049±.001; CLOTH STYLE: 2116; COPPER: HVLP/HVLP. FOR OTHER MATERIALS LINE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. SOLDER MASK OPENING FOR COMPONENT SOLDERING HAS BEEN INCREASED AGAINST PCB LAND PATTERN RECOMMENDATIONS PER NL1008C-6 AND CAN BE DEVIATED FROM THIS DRAWING TO COMPLY WITH CUSTOMERS' DESIGN RULES.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

OUTLINE DRAWING



OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F	G	H	J	K	wt
.098	.079	.028	.012	.024	.024	.008	.028	.043	.024	grams
2.49	2.01	0.71	0.30	0.61	0.61	0.20	0.71	1.09	0.61	.019



CERAMIC

Bandpass Filter

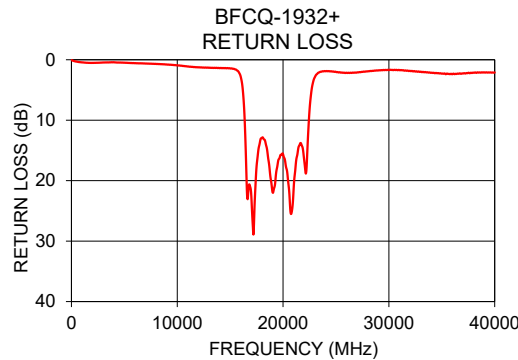
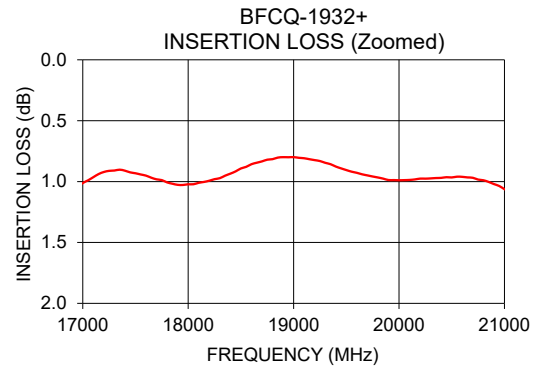
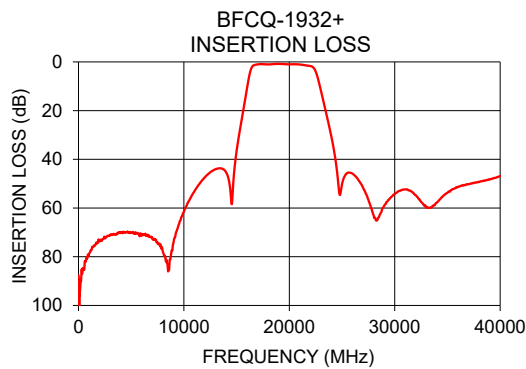
BFCQ-1932+

Mini-Circuits

50Ω 17.7 to 21 GHz

TYPICAL PERFORMANCE DATA AT 25°C

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
10	87.66	0.06
1000	78.83	0.43
2000	73.60	0.52
3000	70.89	0.45
4000	70.29	0.41
7000	72.09	0.63
8800	78.39	0.76
9200	71.16	0.81
10200	59.46	0.95
10700	55.29	1.06
14500	57.54	1.37
15100	33.62	1.44
17700	0.98	14.54
19300	0.85	19.48
21000	1.06	21.33
26000	45.91	2.15
30000	54.32	1.70
32000	54.76	1.84
36000	51.33	2.38
40000	46.89	2.11



NOTES

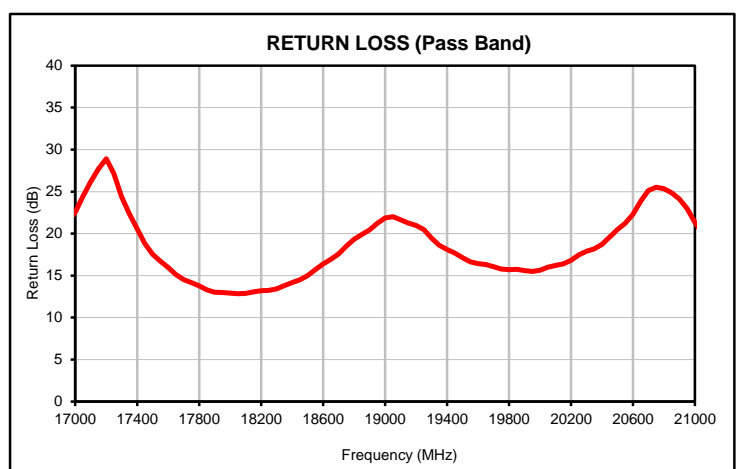
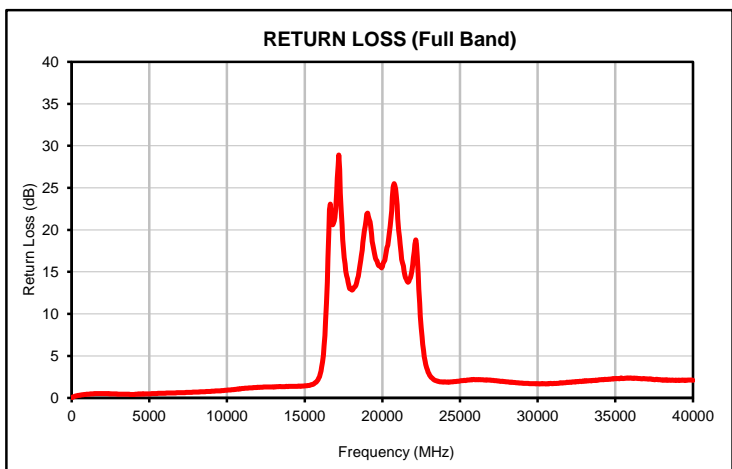
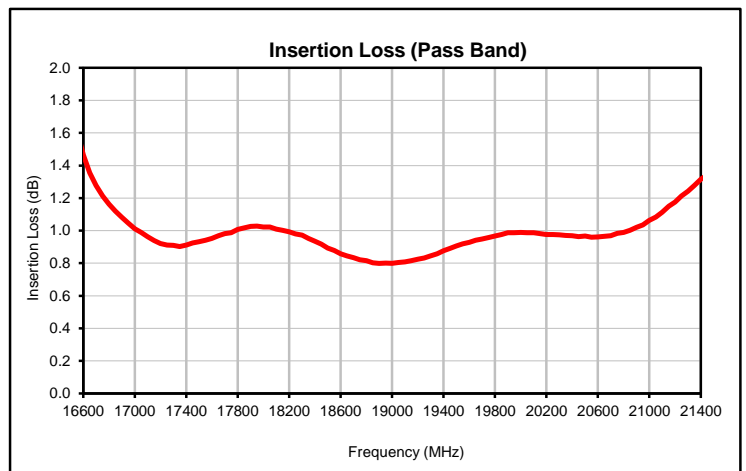
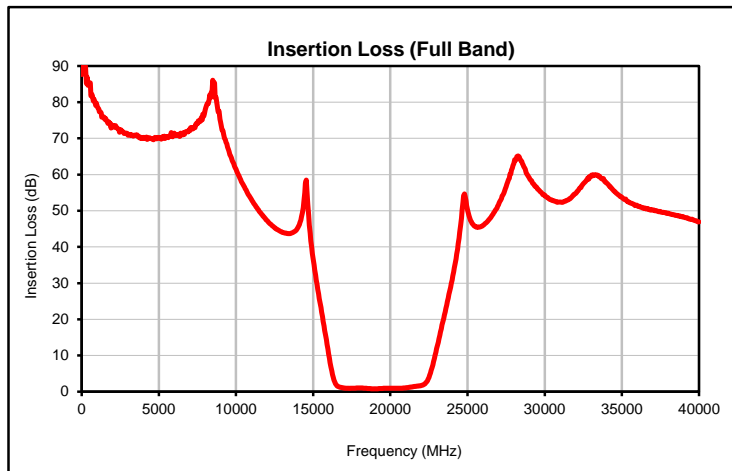
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



Typical Performance Data

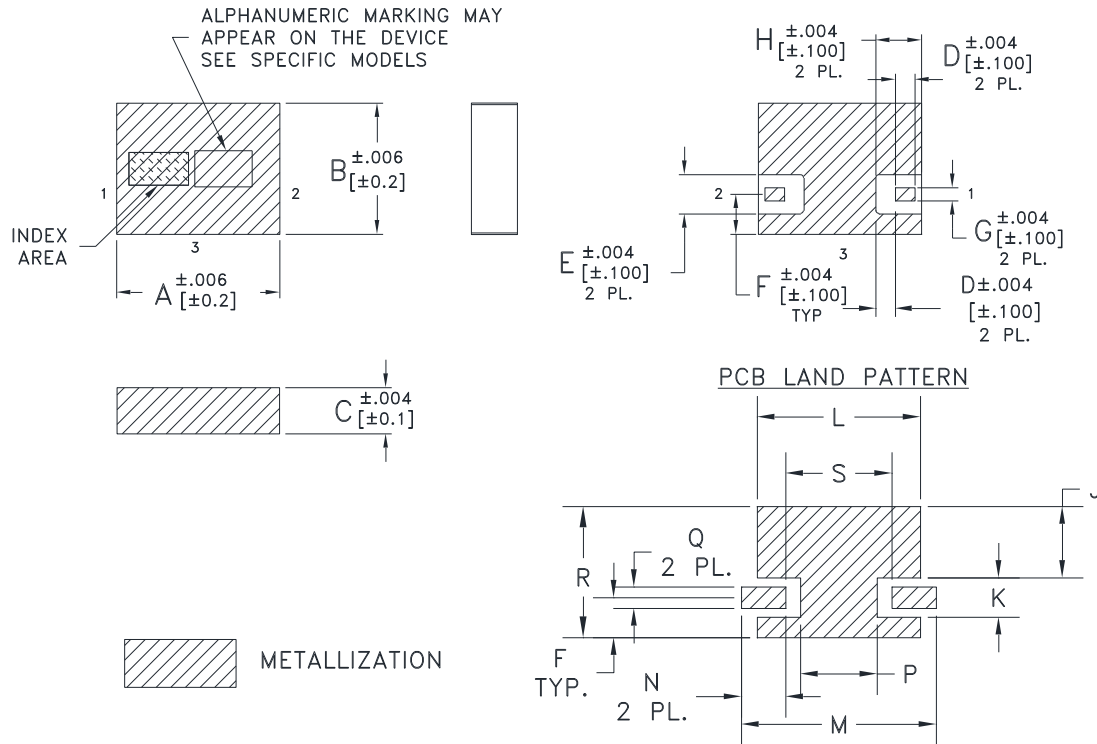
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
100	95.48	0.13
500	85.43	0.31
1000	78.83	0.43
2000	73.60	0.52
3000	70.89	0.45
4000	70.29	0.41
5000	70.08	0.49
6000	71.41	0.57
7000	72.09	0.63
8000	77.96	0.69
9000	74.51	0.79
10000	61.52	0.92
11000	53.06	1.11
12000	47.31	1.25
13000	44.05	1.33
14000	45.33	1.38
15000	36.58	1.43
16000	10.48	2.82
16600	1.46	22.44
17000	1.01	22.56
17700	0.98	14.54
18200	0.99	13.18
18600	0.86	16.39
19000	0.80	21.88
19300	0.85	19.48
19800	0.97	15.71
20200	0.98	16.82
20600	0.96	22.29
21000	1.06	21.33
21400	1.32	15.09
22000	1.70	16.66
23000	11.86	2.89
24000	30.91	1.90
25000	50.23	2.02
26000	45.91	2.15
27000	51.67	2.09
28000	63.02	1.91
29000	59.11	1.77
30000	54.32	1.70
31000	52.39	1.71
32000	54.76	1.84
33000	59.64	1.98
34000	57.70	2.16
35000	53.74	2.29
36000	51.33	2.38
37000	50.28	2.27
38000	49.33	2.14
39000	48.21	2.08
40000	46.89	2.11

Typical Performance Curves



Outline Dimensions

NL1008C-7



SUGGESTED LAYOUT FOR PCB LAND PATTERN
TOLERANCE TO BE WITHIN $\pm .002$

CASE#	A	B	C	D	E	F	G	H	J	K	L
NL1008C-7	.098 (2.50)	.079 (2.00)	.028 (.70)	.012 (.30)	.024 (.61)	.024 (.61)	.008 (.20)	.028 (.70)	.043 (1.09)	.024 (.60)	.098 (2.50)

CASE#	M	N	P	Q	R	S	WT, GRAM
NL1008C-7	.118 (3.00)	.027 (.70)	.046 (1.20)	.013 (.30)	.079 (2.00)	.064 (1.63)	.019

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

1. Open style, ceramic base.
2. Termination finish:

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

3. Pad tolerance is non-cumulative. Minimum spacing between each pad is .004.
4. Line width should be designed to match 50 Ω characteristic depending on PCB material and thickness.



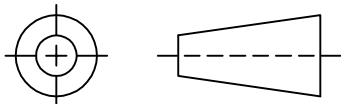
INTERNET <http://www.minicircuits.com>

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

Distribution Centers NORTH AMERICA 800-654-7949 • 417-335-5935 • Fax 417-335-5945 • EUROPE 44-1252-832600 • Fax 44-1252-837010

Mini-Circuits ISO 9001 & ISO 14001 Certified

THIRD ANGLE PROJECTION



REVISIONS

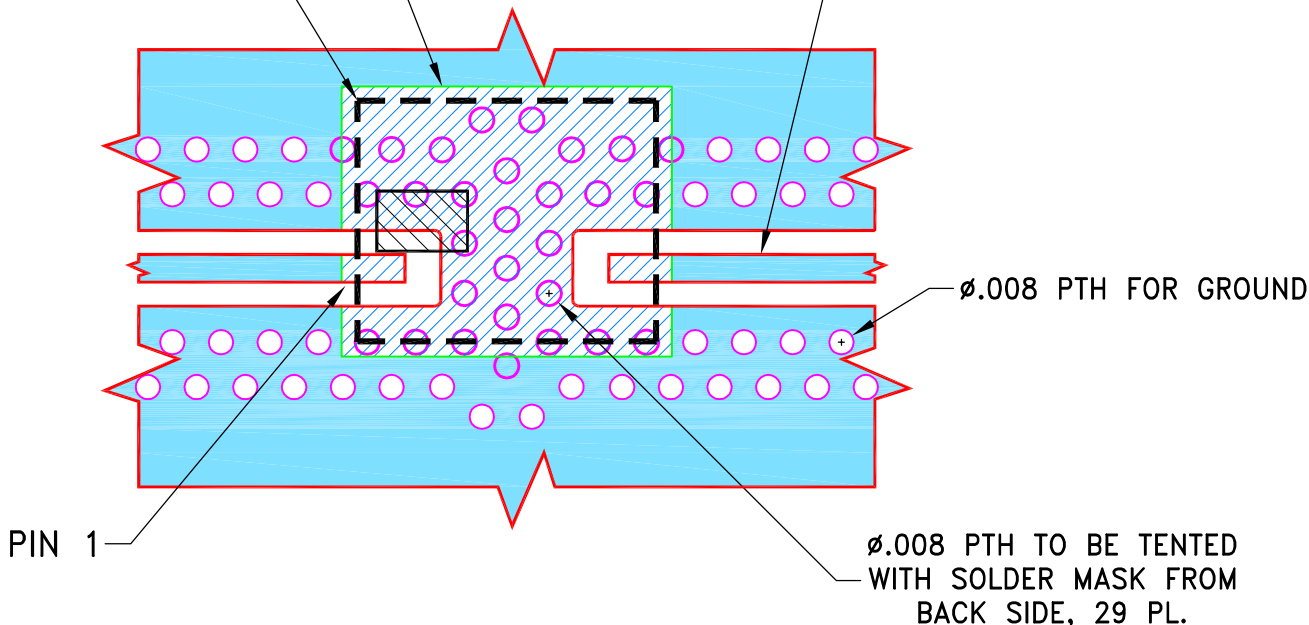
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	ECO-007756	NEW RELEASE	05/12/21	ITG	IL

SUGGESTED MOUNTING CONFIGURATION
FOR NL1008C-6 CASE STYLE

SOLDER MASK BORDER
(SEE NOTE 2)

PACKAGE OUTLINE

COPLANAR WAVEGUIDE:
.0091±.001 TRACE WIDTH &
.0079±.001 GAP, 2 PL.



Ø.008 PTH FOR GROUND

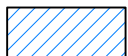
Ø.008 PTH TO BE TENTED
WITH SOLDER MASK FROM
BACK SIDE, 29 PL.

NOTES:

1. COPLANAR WAVEGUIDE PARAMETERS ARE SHOWN FOR MEGTRON-7 R5785(N); DIELECTRIC THICKNESS: .0049±.001; CLOTH STYLE: 2116; COPPER: HVLP/HVLP. FOR OTHER MATERIALS LINE WIDTH & GAP MAY NEED TO BE MODIFIED.
2. SOLDER MASK OPENING FOR COMPONENT SOLDERING HAS BEEN INCREASED AGAINST PCB LAND PATTERN RECOMMENDATIONS PER NL1008C-6 AND CAN BE DEVIATED FROM THIS DRAWING TO COMPLY WITH CUSTOMERS' DESIGN RULES.
3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).



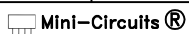
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES	DRAWN	ITG	05/12/21
TOLERANCES ON:	CHECKED	GF	05/12/21
2 PL DECIMALS ±	APPROVED	IL	05/12/21
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			



Mini-Circuits® 13 Neptune Avenue
Brooklyn NY 11235

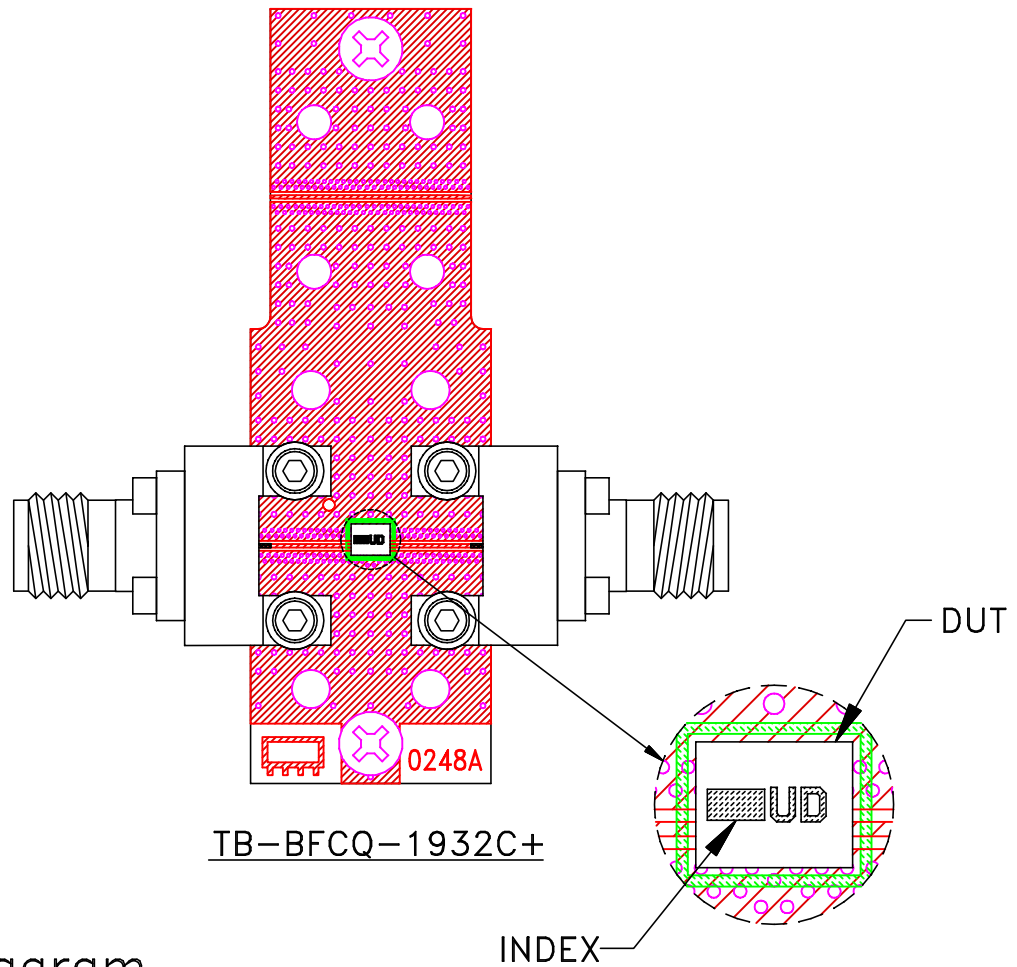
PL, NL1008C-6, TB-BFCQ-XXXX+



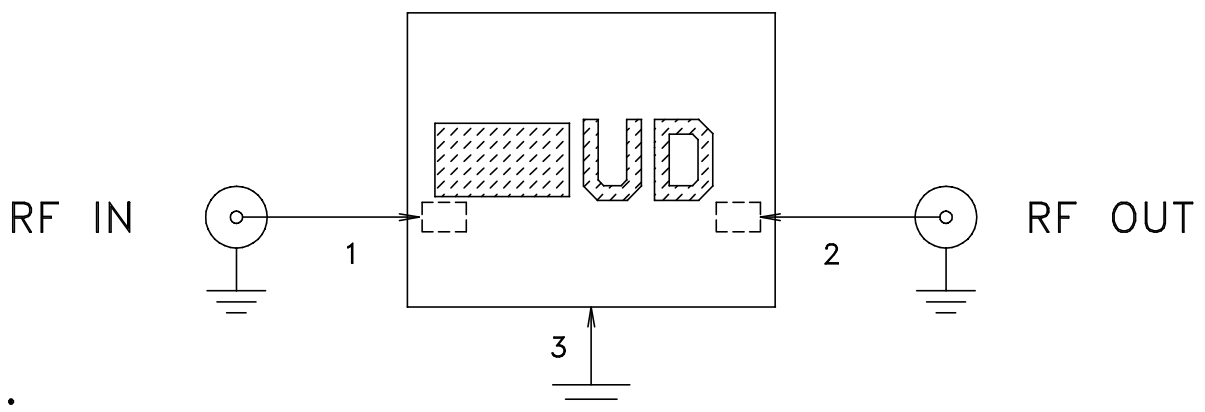
THIS DOCUMENT AND ITS CONTENTS ARE THE PROPERTY OF MINI-CIRCUITS. EXCEPT FOR USE EXPRESSLY GRANTED, IN WRITING, TO ITS VENDORS, VENDEE AND THE UNITED STATES GOVERNMENT, MINI-CIRCUITS RESERVES ALL PROPRIETARY DESIGN, USE, MANUFACTURING AND REPRODUCTION RIGHTS THERETO. THESE CONTENTS SHALL NOT BE USED, DUPLICATED OR DISCLOSED TO ANY OUTSIDE PARTY, IN WHOLE OR IN PART, WITHOUT WRITTEN PERMISSION OF MINI-CIRCUITS.

SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-707	OR
FILE:	98PL707	SCALE: 15:1	SHEET: 1 OF 1

Evaluation Board and Circuit



Schematic diagram



Notes:

1. 50 Ohm 1.85 Female connectors.
2. PCB Material: Megtron 7(N) or equivalent,
Dielectric Constant=3.4, Thickness=.005 inch.

 Mini-Circuits®



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Mechanical Shock	50g, 11ms half-sine, 18 shocks applied each to 3 axes	MIL-STD-202 Method 213, Condition A
Vibration	10-2000Hz sine, 20g, 12 cycles applied each to 3 axes	MIL-STD-202, Method 204, Condition D
Constant Acceleration	30Kg, Y1 Direction	MIL-STD-883, Method 2001, Condition E
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	